Optical Fiber Telecommunications

A: COMPONENTS AND SUBSYSTEMS

IVAN P. KAMINOW
TINGYE LI
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Optical Fiber Telecommunications V A

Components and Subsystems

Edited by

Ivan P. Kaminow

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Optical Fiber Telecommunications V A

About the Editors

Ivan P. Kaminow retired from Bell Labs in 1996 after a 42-year career. He conducted seminal studies on electrooptic modulators and materials, Raman scattering in ferroelectrics, integrated optics, semiconductor lasers (DBR, ridge-waveguide InGaAsP, and multi-frequency), birefringent optical fibers, and WDM networks. Later, he led research on WDM components (EDFAs, AWGs, and fiber Fabry-Perot Filters), and on WDM local and wide area networks. He is a member of the National Academy of Engineering and a recipient of the IEEE/OSA John Tyndall, OSA Charles Townes, and IEEE/LEOS Quantum Electronics Awards. Since 2004, he has been Adjunct Professor of Electrical Engineering at the University of California, Berkeley.

Tingye Li retired from AT&T in 1998 after a 41-year career at Bell Labs and AT&T Labs. His seminal work on laser resonator modes is considered a classic. Since the late 1960s, he and his groups have conducted pioneering studies on lightwave technologies and systems. He led the work on amplified WDM transmission systems and championed their deployment for upgrading network capacity. He is a member of the National Academy of Engineering and a foreign member of the Chinese Academy of Engineering. He is also a recipient of the IEEE David Sarnoff Award, IEEE/OSA John Tyndall Award, OSA Ives Medal/Quinn Endowment, AT&T Science and Technology Medal, and IEEE Photonics Award.

Alan E. Willner has worked at AT&T Bell Labs and Bellcore, and he is Professor of Electrical Engineering at the University of Southern California. He received the NSF Presidential Faculty Fellows Award from the White House, Packard Foundation Fellowship, NSF National Young Investigator Award, Fulbright Foundation Senior Scholar, IEEE LEOS Distinguished Lecturer, and USC University-Wide Award for Excellence in Teaching. He is a Fellow of IEEE and OSA, and he has been President of the IEEE LEOS, Editor-in-Chief of the IEEE/OSA J. of Lightwave Technology, Editor-in-Chief of Optics Letters, Co-Chair of the OSA Science & Engineering Council, and General Co-Chair of the Conference on Lasers and Electro-Optics.

For Florence, Paula, Leonard, and Ellen with Love—IPK For Edith, Debbie, and Kathy with Love—TL For Michelle, our Children (Moshe, Asher, Ari, Jacob), and my Parents with Love—AEW

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reported [38]. This showed that substantial wavelength tuning was possible by varying the width of the waveguide [39]. Recently, an attempt was made to introduce quantum dots [40, 41] into the high-Q nanocavity shown in Figure 13.8 [42]. Further research and development related to single-photon sources and optical quantum information devices are expected using methods that introduce an active medium.

13.2.2 Three-Dimensional Photonic Crystals

As discussed above, band gap/defect engineering of slab structures in 2D photonic crystals has advanced remarkably. The key to developing slab structures lies in the confinement of light in the direction perpendicular to the slab. However, in 3D photonic crystals, light could also, in principle, be trapped in the direction perpendicular to the crystal using the photonic band gap effect. A 3D photonic crystal is thus the ideal structure and promises the capacity to combine various scientifically interesting effects, including the ultimate control of spontaneous emission. However, because more sophisticated fabrication technology is required compared to that used for 2D photonic crystals, a major focus of current research is on methods of fabrication. The next section briefly touches upon the current state of fabrication technology for 3D photonic crystals, and then introduces some results that prove that it is finally possible to control natural emission, a concern that has been present ever since the beginning of photonic crystal research. The following section also summarizes the current situation regarding light propagation control.

Current State of 3D Photonic Crystal Fabrication Technology

Performing the ultimate band gap/defect engineering necessitates the development of 3D photonic crystals possessing a complete band gap in all directions. The structure shown in Figure 13.1(b) is one of the most common of such structures, and is one of the types being investigated most actively. Crystals displaying most ideal band gap effect in the optical wavelength region were fabricated in 1999 [43]. Figure 13.12 shows an electron microscope image of the structure. This 3D crystal has a so-called woodpile or stacked-stripe structures in which semiconductor stripes (width 200 nm, thickness 200 nm, and period 700 nm) mutually overlap. It has a clear band gap in the wavelength region of $1.55\,\mu m$.

Various attempts at developing 3D crystals continued thereafter, including the use of a micromanipulation technique [44]. Crystals with a band gap in the wavelength region 3–4 μ m were realized. The development of 3D crystal templates based on direct laser beam delineation has also advanced [45–47]. Using surface micromachining technology, crystals are being developed in the region of optical transmission [48].

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Overview of OFT V volumes A & B

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Optical Fiber Telecommunications V (OFT V) is the fifth installment of the OFT series. Now 29 years old, the series is a compilation by the research and development community of progress in optical fiber communications. Each edition reflects the current state-of-the-art at the time. As Editors, we started with a clean slate of chapters and authors. Our goal was to update topics from OFT IV that are still relevant as well as to elucidate topics that have emerged since the last edition.

1.1 FIVE EDITIONS

Installments of the series have been published roughly every 6–8 years and chronicle the natural evolution of the field:

- In the late 1970s, the original *OFT* (Chenoweth and Miller, 1979) was concerned with enabling a simple optical link, in which reliable fibers, connectors, lasers, and detectors played the major roles.
- In the late 1980s, *OFT II* (Miller and Kaminow, 1988) was published after the first field trials and deployments of simple optical links. By this time, the advantages of multiuser optical networking had captured the imagination of the community and were highlighted in the book.
- OFT III (Kaminow and Koch, 1997) explored the explosion in transmission capacity in the early-to-mid 1990s, made possible by the erbium-doped fiber amplifier (EDFA), wavelength division multiplexing (WDM), and dispersion management.

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- By 2002, OFT IV (Kaminow and Li, 2002) dealt with extending the distance and capacity envelope of transmission systems. Subtle nonlinear and dispersive effects, requiring mitigation or compensation in the optical and electrical domains, were explored.
- The present edition of *OFT*, *V*, (Kaminow, Li, and Willner, 2008) moves the series into the realm of network management and services, as well as employing optical communications for ever-shorter distances. Using the high bandwidth capacity in a cost-effective manner for customer applications takes center stage. In addition, many of the topics from earlier volumes are brought up to date; and new areas of research which show promise of impact are featured.

Although each edition has added new topics, it is also true that new challenges emerge as they relate to older topics. Typically, certain devices may have adequately solved transmission problems for the systems of that era. However, as systems become more complex, critical device technologies that might have been considered a "solved problem" previously have new requirements placed upon them and need a fresh technical treatment. For this reason, each edition has grown in sheer size, i.e., adding the new and, if necessary, reexamining the old.

An example of this circular feedback mechanism relates to the fiber itself. At first, systems simply required low-loss fiber. However, long-distance transmission enabled by EDFAs drove research on low-dispersion fiber. Further, advances in WDM and the problems of nonlinear effects necessitated development of nonzero dispersion fiber. Cost considerations and ultra-high-performance systems, respectively, are driving research in plastic fibers and ultra-low-polarization-dependent fibers. We believe that these cycles will continue. Each volume includes a CD-ROM with all the figures from that volume. Select figures are in color. The volume B CD-ROM also has some supplementary Powerpoint slides to accompany Chapter 19 of that volume.

1.2 PERSPECTIVE OF THE PAST 6 YEARS

Our field has experienced an unprecedented upheaval since 2002. The *irrational* exuberance and despair of the technology "bubble-and-bust" had poured untold sums of money into development and supply of optical technologies, which was followed by a depression-like period of over supply. We are happy to say that, by nearly all accounts, the field is gaining strength again and appears to be entering a stage of *rational* growth.

What caused this upheaval? A basis seems to be related to a fundamental discontinuity in economic drivers. Around 2001, worldwide telecom traffic ceased being dominated by the slow-growing voice traffic and was overtaken by the rapidly growing Internet traffic. The business community over-estimated the

growth rate, which generated enthusiasm and demand, leading to unsustainable expectations. Could such a discontinuity happen again? Perhaps, but chastened investors now seem to be following a more gradual and sensible path. Throughout the "bubble-and-bust" until the present, the actual demand for bandwidth has grown at a very healthy $\sim\!80\%$ per year globally; thus, real traffic demand experienced no bubble at all. The growth and capacity needs are real, and should continue in the future.

As a final comment, we note that optical fiber communications is firmly entrenched as part of the global information infrastructure. The only question is how deeply will it penetrate and complement other forms of communications, e.g., wireless, access, and on-premises networks, interconnects, satellites, etc. This prospect is in stark contrast to the voice-based future seen by *OFT*, published in 1979, before the first commercial intercontinental or transatlantic cable systems were deployed in the 1980s. We now have Tb/s systems for metro and long-haul networks. It is interesting to contemplate what topics and concerns might appear in *OFT VI*.

1.3 OFT V VOLUME A: COMPONENTS AND SUBSYSTEMS

1.3.1 Chapter 1. Overview of OFT V volumes A & B (Ivan P. Kaminow, Tingye Li, and Alan E. Willner)

This chapter briefly reviews herewith all the chapters contained in both volumes of OFT V.

1.3.2 Chapter 2. Semiconductor quantum dots: Genesis—The Excitonic Zoo—novel devices for future applications (*Dieter Bimberg*)

The ultimate class of semiconductor nanostructures, i.e., "quantum dots" (QDs), is based on "dots" smaller than the de Broglie wavelength in all three dimensions. They constitute nanometer-sized clusters that are embedded in the dielectric matrix of another semiconductor. They are often self-similar and can be formed by self-organized growth on surfaces. Single or few quantum dots enable novel devices for quantum information processing, and billions of them enable active centers in optoelectronic devices like QD lasers or QD optical amplifiers. This chapter covers the area of quantum dots from growth via various band structures to optoelectronic device applications. In addition, high-speed laser and amplifier operations are described.

1.3.3 Chapter 3. High-speed low-chirp semiconductor lasers (Shun Lien Chuang, Guobin Liu, and Piotr Konrad Kondratko)

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One advantage of using quantum wells and quantum dots for the active region of lasers is the lower induced chirp when such lasers are directly modulated, permitting direct laser modulation that can save on the cost of separate external modulators. This chapter provides a comparison of InAlGaAs with InGaAsP long-wavelength quantum-well lasers in terms of high-speed performance, and extracts the important parameters such as gain, differential gain, photon lifetime, temperature dependence, and chirp. Both DC characteristics and high-speed direct modulation of quantum-well lasers are presented, and a comparison with theoretical models is made. The chapter also provides insights into novel quantum-dot lasers for high-speed operation, including the ideas of p-type doping vs tunneling injection for broadband operation.

1.3.4 Chapter 4. Recent advances in surface-emitting lasers (Fumio Koyama)

Vertical cavity surface-emitting lasers (VCSELs) have a number of special properties (compared with the more familiar edge-emitting lasers) that permit some novel applications. This chapter begins with an introduction which briefly surveys recent advances in VCSELs, several of that are then treated in detail. These include techniques for realizing long-wavelength operation (as earlier VCSELs were limited to operation near 850 nm), the performance of dense VCSEL arrays that emit a range of discrete wavelengths (as large as 110 in number), and MEMS-based athermal VCSELs. Also, plasmonic VCSELs that produce subwavelength spots for high-density data storage and detection are examined. Finally, work on all-optical signal processing and slow light is presented.

1.3.5 Chapter 5. Pump diode lasers (Christoph Harder)

Erbium-doped fiber amplifiers (EDFAs) pumped by bulky argon lasers were known for several years before telecom system designers took them seriously; the key development was a compact, high-power semiconductor pump laser. Considerable effort and investment have gone into today's practical pump lasers, driven by the importance of EDFAs in realizing dense wavelength division multiplexed (DWDM) systems. The emphasis has been on high power, efficiency, and reliability. The two main wavelength ranges are in the neighborhood of 980 nm for low noise and 1400 nm for remote pumping of EDFAs. The 1400-nm band is also suitable for Raman amplifiers, for which very high power is needed.